

# NOT RECOMMENDED FOR NEW DESIGNS

DLPD3V3LC



## 3.3V LOW CAPACITANCE BIDIRECTIONAL TVS

# **Features**

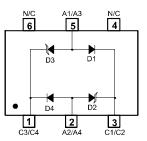
- 330 Watts Peak Pulse Power (tp = 8x20μs)
- Transient Protection for data, signal, and V<sub>CC</sub> bus to IEC61000-4-2 level 4 (ESD)
- Low Capacitance, typ. <3 pF
- Bidirectional Configuration
- Surface Mount Package Ideally Suited for Automated Insertion
- Lead Free By Design/RoHS Compliant (Note 3)
- "Green" Device (Note 4)

# **Mechanical Data**

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
   Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2Ordering Information: See Page 2
- Weight: 0.017 grams (approximate)



Top View



Device Schematic and Pin Out Configuration

# Maximum Ratings, Total Device @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Pulse Power (Note 2)	$P_{pk}$	330	W	

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	286	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics @TA = 25°C unless otherwise specified

Reverse Standoff Voltage	Breakdow V <sub>BR</sub>		Test Current	Max. Reverse Leakage @ V <sub>RWM</sub> (Note 7)	Max. Clamping Voltage @ I <sub>p</sub> = 1A (Note 2)	Max. Clamping Voltage V <sub>C</sub> @ I <sub>PP</sub> (Note 2)	Max. Peak Pulse Current (Note 2)	Typical Total Capacitance (Note 1)
V <sub>RWM</sub> (V)	Min (V)	Max (V)	I <sub>T</sub> (mA)	I <sub>R</sub> (mA)	V <sub>C</sub> (V)	(V)	I <sub>PP</sub> (A)	(pF)
3.3	4.0		1.0	0.11	8.0	22	15	2.5

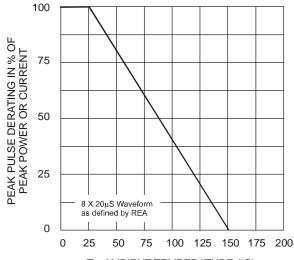
Notes:

- 1.  $V_R = 0V$ , f = 1MHz as measured between pins 1 and 3.
- 2 .  $\,$  tp =  $8x20\mu s.$  See figure 2.
- 3. No purposefully added lead.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- 5. Device mounted on FR-4 PCB with pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 6. From pin 3 to pin 1, and/or from pin 1 to pin 3.
- 7. Short duration pulse test used to minimize self-heating effect.

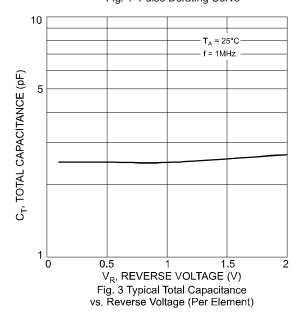


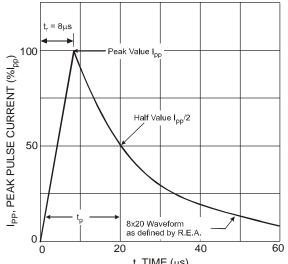
# NOT RECOMMENDED FOR NEW DESIGNS

DLPD3V3LC

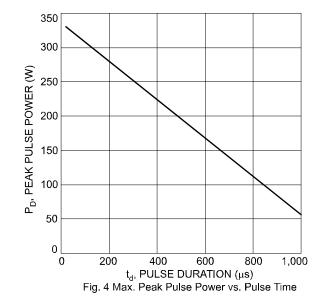


T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Fig. 1 Pulse Derating Curve





t, TIME (μs) Fig. 2 Pulse Waveform

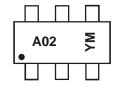


Ordering Information (Note 8)

Part Number		Case	Packaging		
	DLPD3V3LC-7	SOT-26	3000/Tape & Reel		

Notes: 8. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



A02 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: U = 2007) M = Month (ex: 9 = September)

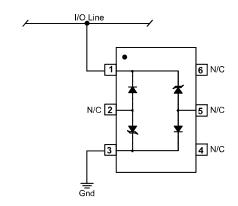
Date Code Key

Date Code Hoj												
Year	2007	20	80	2009	2010	20	)11	2012	2013	20	14	2015
Code	U	\	/	W	Х		Y	Z	Α	I	3	С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

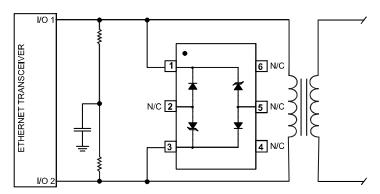


# Typical Applications

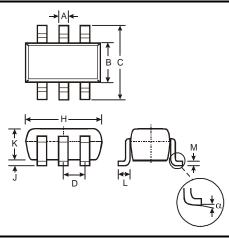
Common-Mode I/O Port Protection



Differential-Mode Ethernet Protection

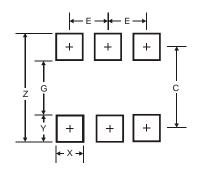


# **Package Outline Dimensions**



SOT-26						
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
C	2.70	3.00	2.80			
D			0.95			
H	2.90	3.10	3.00			
7	0.013	0.10	0.05			
K	1.00	1.30	1.10			
L	0.35	0.55	0.40			
М	0.10	0.20	0.15			
α	0°	8°	_			
All Dimensions in mm						

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
С	2.40
E	0.95



# NOT RECOMMENDED FOR NEW DESIGNS

DLPD3V3LC

### **IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
  - 1. are intended to implant into the body, or
  - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2009, Diodes Incorporated

www.diodes.com